

Y Zero Drift, Precision Instrumentation Amplifier with Digitally Programmable Gain

FEATURES

- 14 Levels of Programmable Gain
- 125dB CMRR Independent of Gain
- Gain Accuracy 0.1% (Typ)
- Maximum Offset Voltage of 10µV
- Maximum Offset Voltage Drift: 50nV/°C
- Rail-to-Rail Input and Output
- Parallel or Serial (SPI) Interface for Gain Setting
- Supply Operation: 2.7V to ±5.5V
- Typical Noise: 2.5µV_{P-P} (0.01Hz to 10Hz)
- 16-Lead SSOP and 12-Lead DFN Packages

APPLICATIONS

- Thermocouple Amplifiers
- Electronic Scales
- Medical Instrumentation
- Strain Gauge Amplifier
- High Resolution Data Acquisition

DESCRIPTION

The LTC®6915 is a precision programmable gain instrumentation amplifier. The gain can be programmed to 0, 1, 2, 4, 8, 16, 32, 64, 128, 256, 512, 1024, 2048, or 4096 through a parallel or serial interface. The CMRR is typically 125dB with a single 5V supply with any programmed gain. The offset is below $10\mu V$ with a temperature drift of less than $50nV/^{\circ}C$.

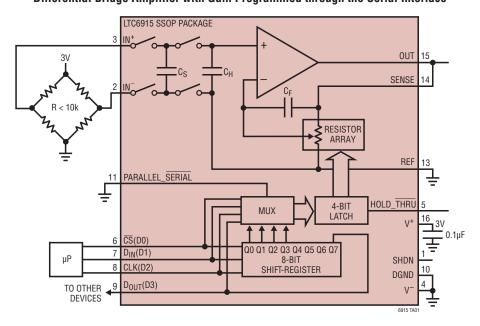
The LTC6915 uses charge balanced sampled data techniques to convert a differential input voltage into a single ended signal that is in turn amplified by a zero-drift operational amplifier.

The differential inputs operate from rail-to-rail and the single-ended output swings from rail-to-rail. The LTC6915 can be used in single power supply applications as low as 2.7V, or with dual ±5V supplies. The LTC6915 is available in a 16-lead SSOP package and a 12-lead DFN surface mount package.

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TYPICAL APPLICATION

Differential Bridge Amplifier with Gain Programmed through the Serial Interface





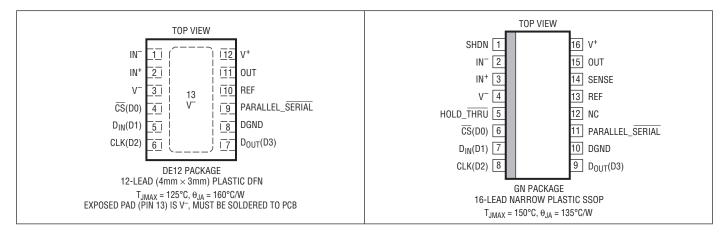
ABSOLUTE MAXIMUM RATINGS

(Note 1)

Total Supply Voltage (V+ to V-)	11V
Input Current	±10mA
V _{IN} ⁺ - V _{REF}	5.5V
V _{IN} ⁻ – V _{REF}	5.5V
V ⁺ – V _{DGND}	5.5V
V _{DGND} - V ⁻	5.5V
Digital Input Voltage	V ⁻ to V ⁺
Operating Temperature Range	
LTC6915C(0°C to 70°C

LTC6915I	_40°C to 85°C
LTC6915H	
Junction Temperature	
(GN Package)	150°C
(DFN Package)	125°C
Storage Temperature	
(GN Package)	–65°C to 150°C
(DFN Package)	65°C to 125°C
Lead Temperature (Soldering 10 sec).	300°C

PIN CONFIGURATION



ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC6915CDE#PBF	LTC6915CDE#TRPBF	6915	12-Lead (4mm × 3mm) Plastic DFN	0°C to 70°C
LTC6915IDE#PBF	LTC6915IDE#TRPBF	69151	12-Lead (4mm × 3mm) Plastic DFN	-40°C to 85°C
LTC6915CGN#PBF	LTC6915CGN#TRPBF	6915	16-Lead Narrow Plastic SSOP	0°C to 70°C
LTC6915IGN#PBF	LTC6915IGN#TRPBF	69151	16-Lead Narrow Plastic SSOP	-40°C to 85°C
LTC6915HGN#PBF	LTC6915HGN#TRPBF	6915H	16-Lead Narrow Plastic SSOP	-40°C to 125°C
LEAD BASED FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC6915CDE	LTC6915CDE#TR	6915	12-Lead (4mm × 3mm) Plastic DFN	0°C to 70°C
LTC6915IDE	LTC6915IDE#TR	69151	12-Lead (4mm × 3mm) Plastic DFN	-40°C to 85°C
LTC6915CGN	LTC6915CGN#TR	6915	16-Lead Narrow Plastic SSOP	0°C to 70°C
LTC6915IGN	LTC6915IGN#TR	69151	16-Lead Narrow Plastic SSOP	-40°C to 85°C
LTC6915HGN	LTC6915HGN#TR	6915H	16-Lead Narrow Plastic SSOP	-40°C to 125°C

Consult LTC Marketing for parts specified with wider operating temperature ranges.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

LINEAR

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25\,^{\circ}\text{C}$.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V+ = 3V, V-	= 0V, V _{REF} = 200mV						
	Gain Error (Note 2)	$A_V = 1 (R_L = 10k)$	•	-0.075	0	0.075	%
	Gain Error (Note 2)	A _V = 2 to 32 (R _L = 10k)	•	-0.5	0	0.5	%
	Gain Error (Note 2)	$A_V = 64 \text{ to } 1024 \text{ (R}_L = 10 \text{k)}$	•	-0.6	-0.1	0.6	%
	Gain Error (Note 2)	A _V = 2048, 4096 (R _L = 10k)	•	-1	-0.2	1.0	%
	Gain Nonlinearity	A _V = 1	•		3	15	ppm
V _{OS}	Input Offset Voltage (Note 3)	V _{CM} = 200mV			-3	±10	μV
	Average Input Offset Drift (Note 3)	T _A = -40°C to 85°C T _A = 85°C to 125°C	•			±50 ±100	nV/°C nV/°C
I _B	Average Input Bias Current (Note 4)	V _{CM} = 1.2V	•		5	10	nA
I _{OS}	Average Input Offset Current (Note 4)	V _{CM} = 1.2V	•		1.5	3	nA
en	Input Noise Voltage	DC to 10Hz			2.5		μV _{P-P}
V+ = 3V, V-	= 0V, V _{REF} = 200mV	'		,			
CMRR	Common Mode Rejection Ratio	$\begin{array}{c} A_V = 1024, \ V_{CM} = 0V \ to \ 3V, \ LTC6915C \\ A_V = 1024, \ V_{CM} = 0.1V \ to \ 2.9V, \ LTC6915I \\ A_V = 1024, \ V_{CM} = 0V \ to \ 3V, \ LTC6915I \\ A_V = 1024, \ V_{CM} = 0.1V \ to \ 2.9V, \ LTC6915H \\ A_V = 1024, \ V_{CM} = 0V \ to \ 2.97V, \ LTC6915H \end{array}$	•	100 100 95 100 85	119 119 119		dB dB dB dB dB
PSRR	Power Supply Rejection Ratio (Note 5)	V _S = 2.7V to 6V	•	110	116		dB
	Output Voltage Swing High (Referenced to V ⁻)	Sourcing 200µA Sourcing 2mA	•	2.95 2.75	2.98 2.87		V
	Output Voltage Swing Low (Referenced to V ⁻)	Sinking 200µA Sinking 2mA	•		18 130	50 300	mV mV
	Supply Current, Parallel Mode	No Load at OUT, V _{CM} = 200mV	•		0.88	1.3	mA
	Supply Current, Serial Mode (Note 6)	No Load at OUT, Capacitive Load at D _{OUT} (C _L) = 15pF, Continuous CLK Frequency = 4MHz, $\overline{\text{CS}}$ = LOW, Gain Control Code = 0001	•		1.1	1.65	mA
	Supply Current Shutdown	V _{SHDN} = 2.7V (Hardware Shutdown) V _{SHDN} = 1V, Gain Control Code = 0000 (Software Shutdown)	•		1 125	4 180	μA μA
	SHDN Input High		•	2.7			V
	SHDN Input Low		•			1	V
	SHDN and HOLD_THRU Input Current (Note 2)		•			5	μA
	Internal Op Amp Gain Bandwidth				200		kHz
	Slew Rate				0.2		V/µs
	Internal Sampling Frequency				3		kHz
V+ = 5V, V-	= 0V, V _{REF} = 200mV			•			
	Gain Error (Note 2)	$A_V = 1 (R_L = 10k)$	•	-0.075	0	0.075	%
	Gain Error (Note 2)	A _V = 2 to 32 (R _L = 10k)	•	-0.5	0	0.5	%
	Gain Error (Note 2)	A _V = 64 to 1024 (R _L = 10k)	•	-0.6	-0.1	0.6	%
	Gain Error (Note 2)	A _V = 2048, 4096 (R _L = 10k)	•	-1	-0.2	1	%
	Gain Nonlinearity	A _V = 1	•		3	15	ppm



ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25\,^{\circ}\text{C}$.

$\overline{V_{OS}}$	Input Offset Voltage (Note 3)	V _{CM} = 200mV			-3	±10	μV
	Average Input Offset Drift (Note 3)	T _A = -40°C to 85°C T _A = 85°C to 125°C	•			±50 ±100	nV/°C nV/°C
	Average Input Bias Current (Note 4)	V _{CM} = 1.2V	•		5	10	nA
I _{OS}	Average Input Offset Current (Note 4)	V _{CM} = 1.2V	•		1.5	3	nA
CMRR	Common Mode Rejection Ratio	$\begin{array}{l} A_V = 1024, \ V_{CM} = 0V \ to \ 5V, \ LTC6915C \\ A_V = 1024, \ V_{CM} = 0.1V \ to \ 4.9V, \ LTC6915I \\ A_V = 1024, \ V_{CM} = 0V \ to \ 5V, \ LTC6915I \\ A_V = 1024, \ V_{CM} = 0.1V \ to \ 4.9V, \ LTC6915H \\ A_V = 1024, \ V_{CM} = 0V \ to \ 4.97V, \ LTC6915H \end{array}$	•	105 105 95 100 85	125 125 125		dB dB dB dB
PSRR	Power Supply Rejection Ratio (Note 5)	V _S = 2.7V to 6V	•	110	116		dB
	Output Voltage Swing High	Sourcing 200µA Sourcing 2mA	•	4.95 4.80	4.99 4.93		V
	Output Voltage Swing Low	Sinking 200µA Sinking 2mA	•		17 120	50 300	mV mV
V ⁺ = 5V, \	<i>I</i> ⁻ = 0V, V _{REF} = 200mV						
	Supply Current, Parallel Mode	No Load at OUT, V _{CM} = 200mV	•		0.95	1.48	mA
	Supply Current, Serial Mode (Note 6)	No Load at OUT, Capacitive Load at D_{OUT} (C_L) = 15pF, Continuous CLK Frequency = 4MHz, \overline{CS} = LOW, Gain Control Code = 0001	•		1.4	2	mA
	Supply Current, Shutdown	V _{SHDN} = 4.5V (Hardware Shutdown) V _{SHDN} = 1V, Gain Control Code = 0000 (Software Shutdown)	•		2 135	10 200	μΑ μΑ
	SHDN Input High		•	4.5			V
	SHDN Input Low		•			1	V
	SHDN and HOLD_THRU Input Current (Note 2)		•			5	μA
	Internal Op Amp Gain Bandwidth				200		kHz
	Slew Rate				0.2		V/µs
	Internal Sampling Frequency				3		kHz
V+ = 5V, \	/ ⁻ = -5V, V _{REF} = 0V						
	Gain Error (Note 2)	$A_V = 1 (R_L = 10k)$	•	-0.075	0	0.075	%
	Gain Error (Note 2)	$A_V = 2 \text{ to } 32 \text{ (R}_L = 10 \text{k)}$	•	-0.5	0	0.5	%
	Gain Error (Note 2)	$A_V = 64 \text{ to } 1024 \text{ (R}_L = 10 \text{k)}$	•	-0.6	-0.1	0.6	%
	Gain Error (Note 2)	A _V = 2048, 4096 (R _L = 10k)	•	-1	-0.2	1	%
	Gain Nonlinearity	A _V = 1	•		3	15	ppm
V _{OS}	Input Offset Voltage (Note 3)	V _{CM} = 0mV			5	±20	μV
	Average Input Offset Drift (Note 3)	T _A = -40°C to 85°C T _A = 85°C to 125°C	•			±50 ±100	nV/°C nV/°C
l _{os}	Average Input Bias Current (Note 4)	V _{CM} = 1V	•		4	10	nA
	Average Input Offset Current (Note 4)	V _{CM} = 1V	•		1.5	3	nA

ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25\,^{\circ}\text{C}$.

OMDD	Common Mada Daisation Datia	A 1004 V		105	100		
CMRR	Common Mode Rejection Ratio	$A_V = 1024$, $V_{CM} = -5V$ to 5V, LTC6915C $A_V = 1024$, $V_{CM} = -4.9V$ to 4.9V, LTC6915I		105 105	123 123		dB dB
		$A_V = 1024$, $V_{CM} = -5V$ to 5V, LTC6915I	•	100	123		dB
		$A_V = 1024$, $V_{CM} = -4.9V$ to 4.9V, LTC6915H	•	100			dB
PSRR	Power Supply Rejection Ratio (Note 5)	$A_V = 1024$, $V_{CM} = -5V$ to 4.97V, LTC6915H $V_S = 2.7V$ to 11V	•	90	116		dB dB
1 01111	Output Voltage Swing High	Sourcing 200µA		4.97	4.99		V
	Output Voltage Swing riigii	Sourcing 200µA Sourcing 2mA	•	4.90	4.99		V
	Output Voltage Swing Low	Sinking 200µA Sinking 2mA	•		-4.98 -4.90	-4.92 -4.70	V V
	Supply Current, Parallel Mode	No Load, V _{CM} = 0mV	•		1.1	1.6	mA
	Supply Current, Serial Mode (Note 6)	No Load at OUT, Capacitive Load at D _{OUT} (C _L) = 15pF, Continuous CLK Frequency = 4MHz, $\overline{\text{CS}}$ = LOW, Gain Control Code = 0001	•		1.73	2.48	mA
	Supply Current, Shutdown	V _{SHDN} = 4V (Hardware Shutdown) V _{SHDN} = 1V, Gain Control Code = 0000 (Software Shutdown)	•		160	25 240	μA μA
	SHDN Input High		•	4			V
	SHDN Input Low		•			1	V
$V^+ = 5V, V$	/ ⁻ = -5V, V _{REF} = 0V						
	SHDN and HOLD_THRU Input Current (Note 2)		•			5	μΑ
	Internal Op Amp Gain Bandwidth				200		kHz
	Slew Rate				0.2		V/µs
	Internal Sampling Frequency				3		kHz
Digital I/0	D, All Digital I/O Voltage Referenced to DGND						
V_{IH}	Digital Input High Voltage		•	2.0			V
V_{IL}	Digital Input Low Voltage		•			8.0	V
V_{OH}	Digital Output High Voltage	Sourcing 500µA	•	V ⁺ - 0.3			V
V_{OL}	Digital Output Low Voltage	Sinking 500μA	•			0.3	V
	Digital Input Leakage	$V^{+} = 5V, V^{-} = -5V, V_{IN} = 0V \text{ to } 5V$	•			±2	μΑ
Timing, V	/+ = 2.7V to 4.5V, V ⁻ = 0V (Note 7)						
<u>t</u> 1	D _{IN} Valid to CLK Setup		•	60			ns
t ₂	D _{IN} Valid to CLK Hold		•	0			ns
t ₃	CLK Low		•	100			ns
t ₄	CLK High		•	100			ns
t ₅	CS/LD Pulse Width		•	60			ns
t ₆	LSB CLK to CS/LD		•	60			ns
t ₇	CS/LD Low to CLK		•	30			ns
t ₈	D _{OUT} Output Delay	C _L = 15pF	•			125	ns
t ₉	CLK Low to CS/LD Low		•	0			ns



ELECTRICAL CHARACTERISTICS The \bullet denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$.

	W. 4 - W W. W W. W W.		<u> </u>	
liming	, V ⁺ = 4.5V to 5.5V, V ⁻ = 0V (Note 7)			
t ₁	D _{IN} Valid to CLK Setup		• 30	ns
t ₂	D _{IN} Valid to CLK Hold		• 0	ns
t ₃	CLK Low		• 50	ns
t ₄	CLK High		• 50	ns
t ₅	CS/LD Pulse Width		• 40	ns
t_6	LSB CLK to CS/LD		• 40	ns
t ₇	CS/LD Low to CLK		• 20	ns
t ₈	D _{OUT} Output Delay	C _L = 15pF	•	85 ns
t ₉	CLK Low to CS/LD Low		• 0	ns
Timing	, Dual ±4.5V to ±5.5V Supplies (Note 7)			
t ₁	D _{IN} Valid to CLK Setup		• 30	ns
t ₂	D _{IN} Valid to CLK Hold		• 0	ns
$\overline{t_3}$	CLK High		• 50	ns
t ₄	CLK Low		• 50	ns
t ₅	CS/LD Pulse Width		• 40	ns
t ₆	LSB CLK to CS/LD		• 40	ns
$\overline{t_7}$	CS/LD Low to CLK		• 20	ns
t ₈	D _{OUT} Output Delay	C _L = 15pF	•	85 ns
t ₉	CLK Low to CS/LD Low		• 0	ns

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: These parameters are tested at $\pm 5V$ supply; at 3V and 5V supplies they are guaranteed by design.

Note 3: These parameters are guaranteed by design. Thermocouple effects preclude measurement of these voltage levels in high speed automatic test systems. V_{OS} is measured to a limit set by test equipment capability.

Note 4: If the total source resistance is less than 10k, no DC errors result from the input bias current or mismatch of the input bias currents or the mismatch of the resistances connected to IN⁻ and IN⁺.

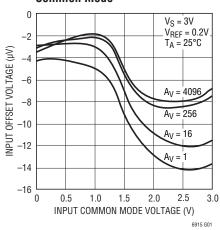
Note 5: The PSRR measurement accuracy depends on the proximity of the power supply bypass capacitor to the device under test. Because of this, the PSRR is 100% tested to relaxed limits at final test. However, their values are guaranteed by design to meet the data sheet limits.

Note 6: Supply current is dependent on the clock frequency. A higher clock frequency results in higher supply current.

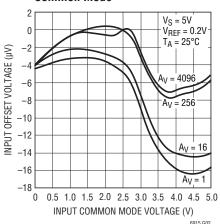
Note 7: Guaranteed by design, not subject to test.

TYPICAL PERFORMANCE CHARACTERISTICS

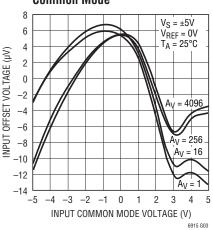
Input Offset Voltage vs Input Common Mode



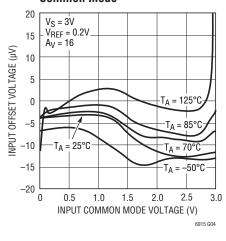
Input Offset Voltage vs Input Common Mode



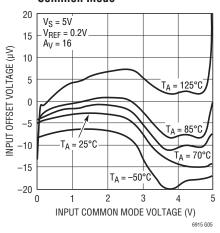
Input Offset Voltage vs Input Common Mode



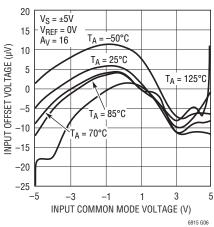
Input Offset Voltage vs Input Common Mode



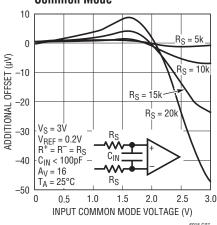
Input Offset Voltage vs Input Common Mode



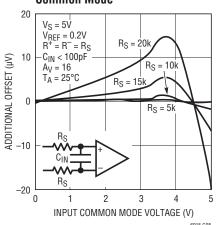
Input Offset Voltage vs Input Common Mode



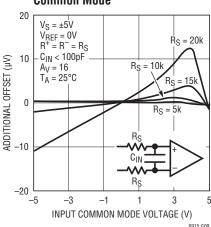
Error Due to Input R_S vs Input Common Mode



Error Due to Input R_S vs Input Common Mode

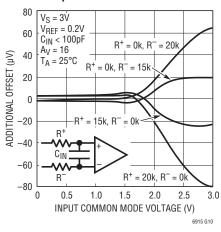


Error Due to Input $R_{\mbox{\scriptsize S}}$ vs Input Common Mode

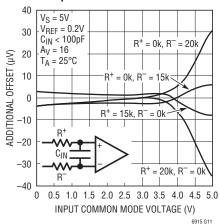


TYPICAL PERFORMANCE CHARACTERISTICS

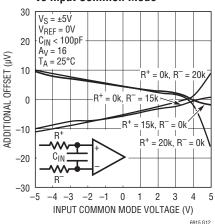
Error Due to Input R_S Mismatch vs Input Common Mode



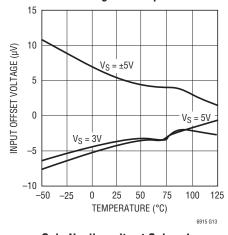
Error Due to Input R_S Mismatch vs Input Common Mode



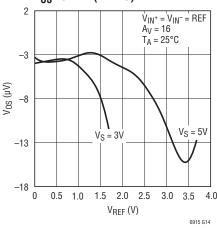
Error Due to Input R_S Mismatch vs Input Common Mode



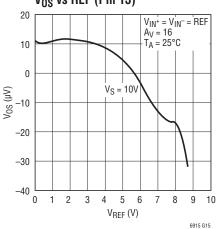
Offset Voltage vs Temperature



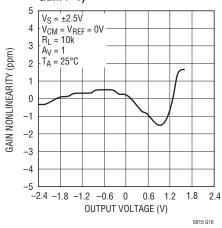
V_{OS} vs REF (Pin 13)



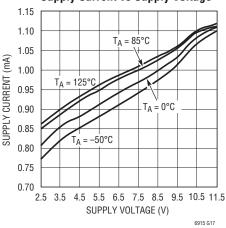
V_{OS} vs REF (Pin 13)



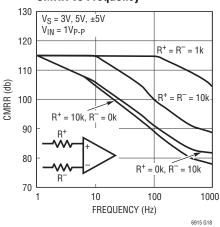
Gain Nonlinearity at Gain = 1 (Gain Nonlinearity Decreases for Gain > 1)



Supply Current vs Supply Voltage



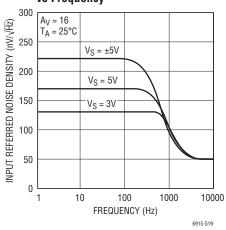
CMRR vs Frequency



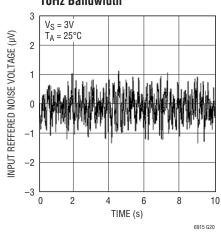


TYPICAL PERFORMANCE CHARACTERISTICS

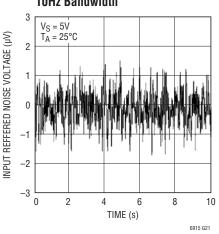
Input Voltage Noise Density vs Frequency



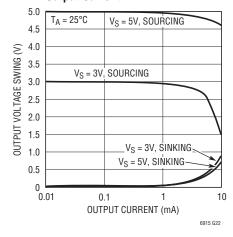
Input Referred Noise in 10Hz Bandwidth



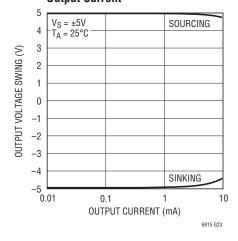
Input Referred Noise in 10Hz Bandwidth



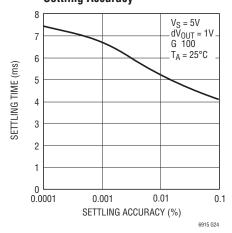
Output Voltage Swing vs Output Current



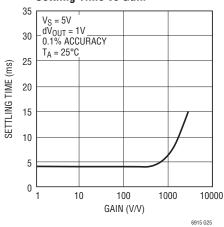
Output Voltage Swing vs Output Current



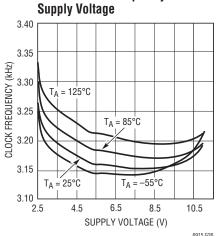
Low Gain Settling Time vs Settling Accuracy



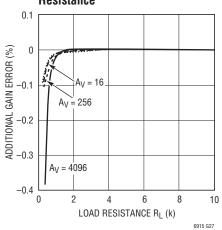
Settling Time vs Gain



Internal Clock Frequency vs



Additional Gain Error vs Load Resistance



PIN FUNCTIONS (DFN/GN)

IN⁻ (**Pin 1/Pin 2**): Inverting Analog Input.

SHDN (Pin 1 GN Package Only): Shutdown Pin. The IC is shut down when SHDN is tied to V⁺. An internal current source pulls this pin to V⁻ when floating.

IN+ (Pin 2/Pin 3): Noninverting Analog Input.

V⁻ (Pin 3/Pin 4): Negative Supply.

CS(D0) (**Pin 4/Pin 6):** TTL Level Input. When in serial control mode, this pin is the chip select input (active low); in parallel control mode, this pin is the LSB of the parallel gain control code.

D_{IN}(**D1**) (**Pin 5/Pin 7**): TTL Level Input. When in serial control mode, this pin is the serial input data; in parallel mode, this pin is the second LSB of the parallel gain control code.

HOLD_THRU (Pin 5 GN Package Only): TTL Level Input for Parallel Control Mode. When HOLD_THRU is high, the parallel data is latched in an internal D-latch.

CLK(D2) (**Pin 6/Pin 8)**: TTL Level Input. When in serial control mode, this pin is the clock of the serial interface; in parallel mode, this pin is the third LSB of the parallel gain control code.

D_{OUT}(**D3**) (**Pin 7/Pin 9**): TTL Level Input. When in serial control mode, this pin is the output of the serial data; in parallel mode, this pin is the MSB of the 4-bit parallel

gain control code. In parallel mode operation, if the data in to D_{OUT} (Pin 9) is from a voltage source greater than V⁺ (Pin 12), then connect a resistor between the voltage source and D_{OUT} to limit the current into Pin 9 to 5mA or less.

DGND (Pin 8/Pin 10): Digital Ground.

PARALLEL_SERIAL (Pin 9/Pin 11): Interface Selection Input. When tied to V⁺, the interface is in parallel mode, i.e., the PGA gain is defined by the parallel codes (D3 ~ D0), i.e., $\overline{CS}(D0)$, $\overline{DATA}(D1)$, CLK(D2), and $\overline{DOUT}(D3)$. When PARALLEL_ \overline{SERIAL} pin is tied to V⁻, the PGA gain is set by the serial interface.

REF (Pin 10/Pin 13): Voltage Reference for PGA output.

OUT (Pin 11/Pin 15): Amplifier Output. The typical current sourcing/sinking of the OUT pin is 1mA. For minimum gain error, the load resistance should be 1k or greater (refer to the Output Voltage Swing vs Output Current and Gain Error vs Load Resistance in the Typical Performance Characteristics section).

V+ (Pin 12/Pin 16): Positive Supply.

SENSE (Pin 14 GN Package Only): Sense Pin. When the PGA drives a low resistance load and the interconnect resistance between the OUT pin and the load is not negligible, tying the SENSE pin as close as possible to the load can improve the gain accuracy.



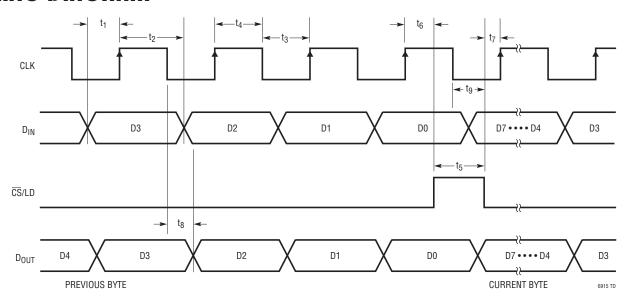
BLOCK DIAGRAMS

(GN Package Only) IN+ 15 OUT 14 SENSE IN-GAIN CONTROL RESISTOR ARRAY 13 REF PARALLEL_SERIAL 11 4-BIT LATCH 5 HOLD_THRU - SHDN $\overline{CS}(D0) = \frac{6}{7}$ $D_{IN}(D1) = \frac{8}{8}$ QO Q1 Q2 Q3 Q4 Q5 Q6 Q7 8-BIT SHIFT-REGISTER 16 V⁺ 10 DGND CLK(D2) D_{OUT}(D3)

(DFN Package Only) IN^+ 11 OUT IN-GAIN CONTROL RESISTOR ARRAY 10 REF PARALLEL_SERIAL 4-BIT LATCH DGND $\overline{CS}(D0) \\ D_{IN}(D1)$ Q0 Q1 Q2 Q3 Q4 Q5 Q6 Q7 8-BIT SHIFT-REGISTER 5 12 V+ 8 DGND CLK(D2) $D_{OUT}(D3)$



TIMING DIAGRAM



OPERATION

Theory of Operation (Refer to Block Diagrams)

The LTC6915 uses an internal capacitor (C_S) to sample a differential input signal riding on a DC common mode voltage (the sampling rate is 3kHz and the input switchon resistance is 1k to 2k, depending on the power supply voltage). This capacitor's charge is transferred to a second internal hold capacitor (C_H) translating the common mode voltage of the input differential signal to that of REF pin. The resulting signal is amplified by a zero-drift op amp in the noninverting configuration. Gain control within the amplifier occurs by switching resistors from a matched resistor array. The LTC6915 has 14 levels of gain, controlled by the parallel or serial interface. A feedback capacitor C_F helps to reduce the switching noise. Due to the input sampling, an LTC6915 may produce aliasing errors for input signals greater than 1.5kHz (one half the 3kHz sampling frequency). However, if the input signal is bandlimited to less than 1.5kHz then an LTC6915 is useful as instrumentation or as a differential to single-ended AC amplifier with programmable gain.

Parallel Interface

As shown in Figure 1, connecting PARALLEL_SERIAL to V⁺ allows the gain control code to be set through the parallel lines (D3, D2, D1, D0). When HOLD THRU is

low (referenced to DGND) or floating, the parallel gain control bits (D3 ~ D0) directly control the PGA gain. When HOLD_THRU is high, the parallel gain control bits are read into and held by a 4-bit latch. Any change at D3 ~ D0 will not affect the PGA gain when HOLD_THRU is high. Note that the DFN12 package does not have the HOLD_THRU pin. Instead, it is tied to DGND internally. The D_{OUT}(D3) pin is bidirectional (output in serial mode, input in parallel mode). In parallel mode, the voltage at D_{OUT}(D3) cannot exceed V+; otherwise, large currents can be injected to V+ through the parasitic diode (see Figure 2). Connecting a 10k resistor at the D_{OUT}(D3) pin if parallel mode is selected (see Figure 1) is recommended for current limiting.

Serial Interface

Connecting PARALLEL_ \overline{SERIAL} to V⁻ allows the gain control code to be set through the serial interface. When \overline{CS} is low, the serial data on D_{IN} is shifted into an 8-bit shift-register on the rising edge of the clock, with the MSB transferred first (see Figure 3). Serial data on D_{OUT} is shifted out on the clock's falling edge. A high \overline{CS} will load the 4 LSBs of the shift-register into a 4-bit D-latch, which are the gain control bits. The clock is disabled internally when \overline{CS} is pulled high. Note: CLK must be low before \overline{CS} is pulled low to avoid an extra internal clock pulse.



OPERATION

 D_{OUT} is always active in serial mode (never tri-stated). This simplifies the daisy chaining of the multiple devices. D_{OUT} cannot be "wire-or" to other SPI outputs. In addition, D_{OUT} does not return to zero at the end of transmission, i.e. when \overline{CS} is pulled high.

A LTC6915 may be daisy-chained with other LTC6915s or other devices having serial interfaces by connecting

the D_{OUT} to the D_{IN} of the next chip while CLK and \overline{CS} remain common to all chips in the daisy chain. The serial data is clocked to all the chips then the \overline{CS} signal is pulled high to update all of them simultaneously. Figure 4 shows an example of two LTC6915s in a daisy chained SPI configuration.

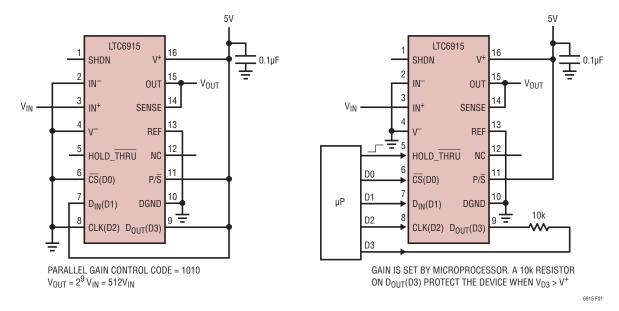


Figure 1. PGA in the Parallel Control Mode

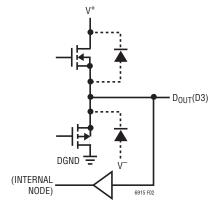


Figure 2. Bidirectional Nature of Dout/D3 Pin

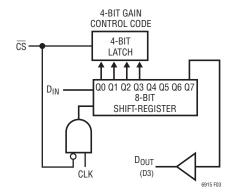


Figure 3. Diagram of Serial Interface (MSB First Out)



OPERATION

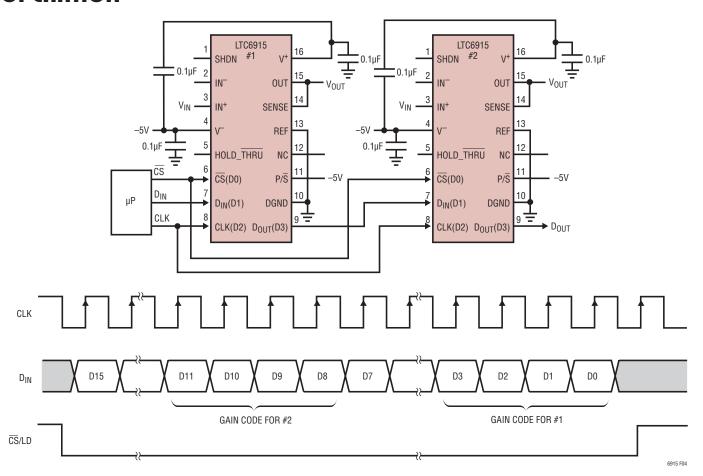


Figure 4. 2 PGAs in a Daisy Chain

The amplifier's gain is set as follows:

D3, D2, D1, D0	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101~ 1111
Gain	0	1	2	4	8	16	32	64	128	256	512	1024	2048	4096

Input Voltage Range

The input common mode voltage range of the LTC6915 is rail-to-rail. However, the following equation limits the size of the differential input voltage:

$$V^- \leq (V_{IN}{}^+ - V_{IN}{}^-) + V_{REF} \leq V^+ - 1.3$$

Where V_{IN}^+ and V_{IN}^- are the voltage of the differential input pins, V^+ and V^- are the positive and negative supply voltages respectively and V_{REF} is the voltage of REF pin. In addition, V_{IN}^+ and V_{IN}^- must not exceed the power supply voltages, i.e.,

$$V^- < V_{IN}^+ < V^+$$
 and $V^- < V_{IN}^- < V^+$

±5 Volt Operation

When using the LTC6915 with supplies over 5.5V, care must be taken to limit the maximum difference between any of the input pins (IN+ or IN-) and the REF pin to 5.5V, i.e.,

$$|V_{IN}^+ - V_{RFF}| < 5.5$$
 and $|V_{IN}^- - V_{RFF}| < 5.5$

If not, the device will be damaged. For example, if rail-to-rail input operation is desired when the supplies are at ± 5 V, the REF pin should be 0, ± 0.5 V. As a second example, if the V⁺ pin is 10V, and the V⁻ and REF pins are at 0, the inputs should not exceed 5.5V.

TECHNOLOGY TECHNOLOGY

OPERATION

Settling Time

The sampling rate is 3kHz and the input sampling period during which C_S is charged to the input differential voltage, V_{IN} , is approximately 150 μ s. First assume that on each input sampling period, C_{S} is charged fully to $V_{IN}.$ Since $C_S = C_H$ (= 1000pF), a change in the input will settle to N bits of accuracy at the op amp noninverting input after N clock cycles or 333µs(N). The settling time at the OUT pin is also affected by the internal op amp. Since the gain bandwidth of the internal op amp is typically 200kHz, the settling time is dominated by the switched-capacitor front end for gains below 100 (see the Low Gain Settling Time vs Settling Accuracy and the Settling Time vs Gain graphs in the Typical Performance Characteristics section). In addition, the worst case settling time after a device-enable (active low on Pin 1 of a GN package) is equal to the settling due to the gain plus the input settling time (333µs • N). For example, if an LTC6915 is enabled with a logic high on Pin 1 then, the maximum settling time to 10 bits of accuracy (0.1%) and a gain equal to 100 is 8.33ms ([333µs • 1024] + 5ms).

Input Current

Whenever the differential input V_{IN} changes, C_H must be charged up to the new input voltage via C_S . This results in an input charging current during each input sampling period. Eventually, C_H and C_S will reach V_{IN} and ideally, the input current would go to zero for DC inputs.

In reality, there are additional parasitic capacitors which disturb the charge on C_S every cycle even if V_{IN} is a DC voltage. For example, the parasitic bottom plate capacitor on C_S must be charged from the voltage on the REF pin to the voltage on the IN^- pin every cycle. The resulting input charging current decays exponentially during each input sampling period with a time constant equal to R_SC_S . If the voltage disturbance due to these currents settles before the end of the sampling period, there will be no errors due to source resistance or the source resistance mismatch between IN^+ and IN^- . With R_S less than 10k, no DC errors occur due to input current mismatch.

In the Typical Performance Characteristics section of this data sheet, there are curves showing the additional error from non-zero source resistance in the inputs. If there are no large capacitors across the inputs, the amplifier is less sensitive to source resistance and source resistance mismatch. When large capacitors are placed across the

inputs, the input charging currents are placed across the inputs. The input charging currents described above result in larger DC errors, especially with source resistor mismatches.

Power Supply Bypassing

In a dual supply operation, connect a $0.1\mu F$ bypass capacitor from each power supply pin (V⁺ and V⁻) to an analog round plance surrounding an LTC6915. The bypass capacitor trace to the supply pins must be less than 0.2 inches (an X7R or X5R capacitor type is recommended). In single supply operation, connect the V⁻ pin to the analog ground plane and bypass the V⁺ pin.

Shutdown Modes

The IC has two shutdown modes, hardware shutdown and software shutdown. When SHDN is tied to V^+ , the IC is in hardware shutdown mode. During this shutdown mode, the gain setting digital interface (serial or parallel) and the main op amp are both disabled, thus the PGA dissipates very small supply current (see the Electrical Characteristic table). When SHDN is floating, an internal current source will pull it down to V^- . The digital interface is turned on to read the gain setting codes. The IC is in normal amplification mode as long as the gain control code is other than 0000. If the gain control code is 0000, the IC operates in software shutdown mode, i.e., the main op amp is turned off so that the PGA dissipates less power. The DFN package does not have hardware shutdown.

Setting the Voltage at the REF Pin

The current coming out of the REF pin may affect the reference voltage at the REF pin (V_{REF}). If V_{REF} is set by a resistive divider then the V_{REF} voltage is a function of the V_{OUT} voltage (see Figure 5). In order to minimize the V_{REF} variations, the total resistance of R1 plus R2 should be much less than 32k (5k or less) or use a voltage reference to set V_{REF} .

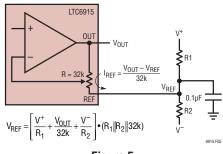


Figure 5

CO1 E f



TYPICAL APPLICATION

Multiplexing Two LTC6915's

Send a gain code of 0000 to one IC to set its output to a high impedance state and send a gain code other than 0000 to the second IC to set it for normal amplification. If both devices are ON, the 200Ω resistors protect the outputs. The sense pin connection maintains gain accuracy for loads 1k or greater.

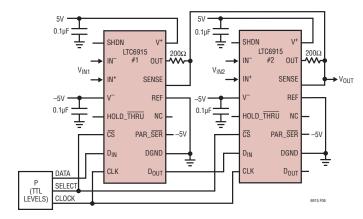


Figure 6. A 2:1 Multiplexing Two LTC6915's with Daisy Chained Gain Control

PACKAGE DESCRIPTION

DE/UE Package 12-Lead Plastic DFN (4mm × 3mm) (Reference LTC DWG # 05-08-1695 Rev D)

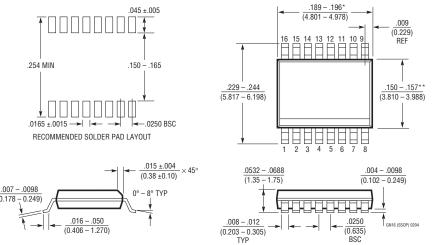
4.00 ±0.10 (2 SIDES) R = 0.115 0.40 ± 0.10 TYP R = 0.05 TYP 0.70 ±0.05 3.30 ±0.05 — 3 30 ±0 10 3.60 ±0.05 3.00 ±0.10 (2 SIDES) 1.70 ± 0.10 2.20 ±0.05 1.70 + 0.05PIN 1 PIN 1 NOTCH R = 0.20 OR PACKAGE (NOTE 6) 0.35 × 45° CHAMFER OUTLINE 0.75 ±0.05 0.25 ± 0.05 0.200 REF ← 0.50 BSC 2.50 REF 2.50 REF BOTTOM VIEW-EXPOSED PAD RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED 0.00 - 0.05

1. DRAWING PROPOSED TO BE A VARIATION OF VERSION (WGED) IN JEDEC PACKAGE OUTLINE M0-229
2. DRAWING NOT TO SCALE

- 3. ALL DIMENSIONS ARE IN MILLIMETERS
- DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE
 MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
 EXPOSED PAD SHALL BE SOLDER PLATED
- 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

GN Package 16-Lead Plastic SSOP (Narrow .150 Inch)

(Reference LTC DWG # 05-08-1641)



NOTE:

- 1. CONTROLLING DIMENSION: INCHES
- 2. DIMENSIONS ARE IN INCHES (MILLIMETERS)
- 3. DRAWING NOT TO SCALE
 - *DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE
 - **DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE

LINEAR

REVISION HISTORY (Revision history begins at Rev B)

REV	DATE	DESCRIPTION	PAGE NUMBER
В	6/11	Revised units for PSRR in Electrical Characteristics	5



TYPICAL APPLICATION

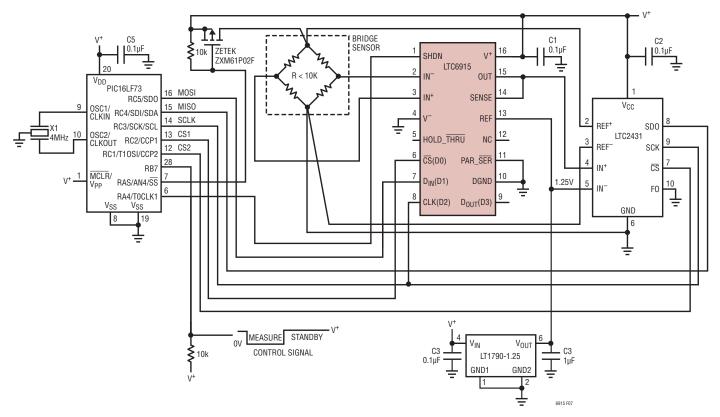


Figure 7. Bridge Amplifier with Programmable Gain and Analog to Digital Conversion. (Standby Current Less than 100µA)

RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC1043	Dual Precision Instrumentation Switched-Capacitor Building Block	Rail-to-Rail Input, 120dB CMRR
LTC1100	Precision Zero-Drift Instrumentation Amplifier	Fixed Gains of 10 or 100, 10µV Offset, 50pA Input Bias Current
LTC1101	Precision, Micropower, Single Supply Instrumentation Amplifier	Fixed Gain of 10 or 100, I _S < 105μA
_TC1167	Single Resistor Gain Programmable, Precision Instrumentation Amplifier	Single Gains Set Resistor, G = 1 to 10,000 Low Noise: 7.5nV/√Hz
LTC1168	Low Power Single Resistor Gain Programmable, Precision Instrumentation Amplifiers	$I_S = 530\mu A$
LTC1789-1	Single Supply, Rail-to-Rail Output, Micropower Instrumentation Amplifier	I _S = 80μA Max
LTC2050	Zero-Drift Operational Amplifier	SOT-23 Package
LTC2051	Dual Zero-Drift Operational Amplifier	MS8 Package
LTC2052	Quad Zero-Drift Operational Amplifier	GN16 Package
LTC2053	Rail-to-Rail Input and Output, Zero-Drift Instrumentation Amplifier with Resistor-Programmable Gain	MS8 Package, 10μV Max V _{OS} , 50nV/°C Max Drift
LTC6800	Rail-to-Rail Input and Output, Instrumentation Amplifier with Resistor-Programmable Gain	MS8 Package, 100μV Max V _{OS} , 250nV/°C Max Drift

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AD624CDZ AD624SD/883B AD625ADZ AD625BDZ AD625JNZ AD625KNZ AD625SD AD627BNZ AD693AD AD693AE AD693AQ

AD694AQ AD694ARZ-REEL AD694BRZ-REEL AD694JNZ AD8221ARMZ-R7 AD8224BCPZ-WP AD8224HBCPZ-WP

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AD8293G160BRJZ-R7 AD8293G80BRJZ-R2 AD8553ARMZ AD8553ARMZ-REEL AD8555ACPZ-REEL7 AD8556ACPZ-R2

AD8556ACPZ-REEL7